

H5N3003P

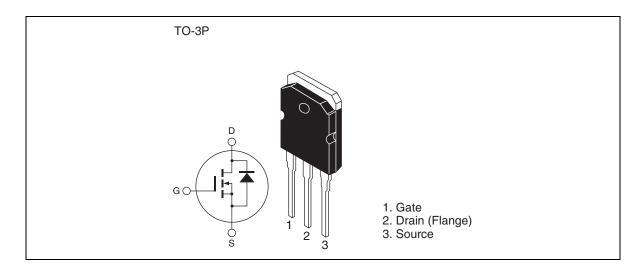
Silicon N Channel MOS FET High Speed Power Switching

REJ03G0007-0200Z (Previous ADE-208-1547A(Z)) Rev.2.00 Aug.01.2003

Features

- Low on-resistance
- Low leakage current
- High Speed Switching

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	300	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I_D	40	A
Drain peak current	I _D (pulse) Note1	160	A
Body-drain diode reverse drain current	I _{DR}	40	A
Body-drain diode reverse drain peak current	I _{DR} (pulse) Note1	160	A
Avalanche current	I _{AP} Note3	30	A
Channel dissipation	Pch ^{Note2}	150	W
Channel to case Thermal Impedance	θch-c	0.833	°C /W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = 25°C

3. Tch ≤ 150°C

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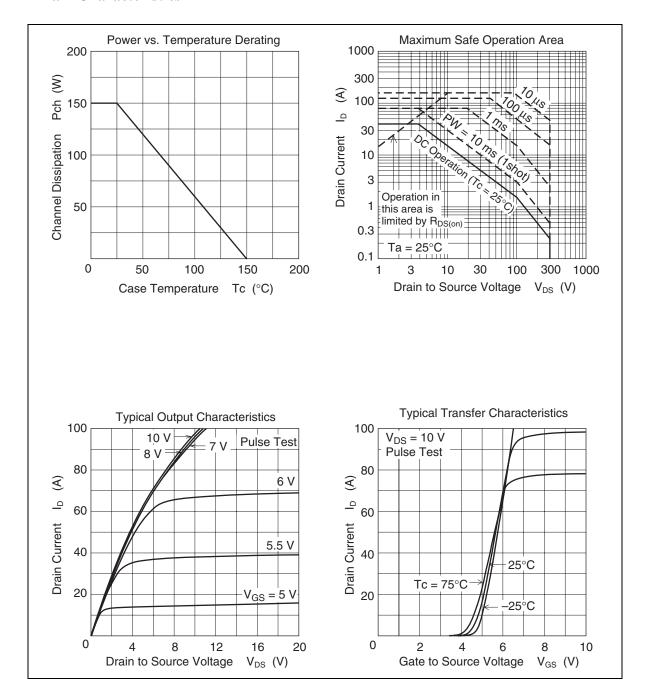
Electrical Characteristics

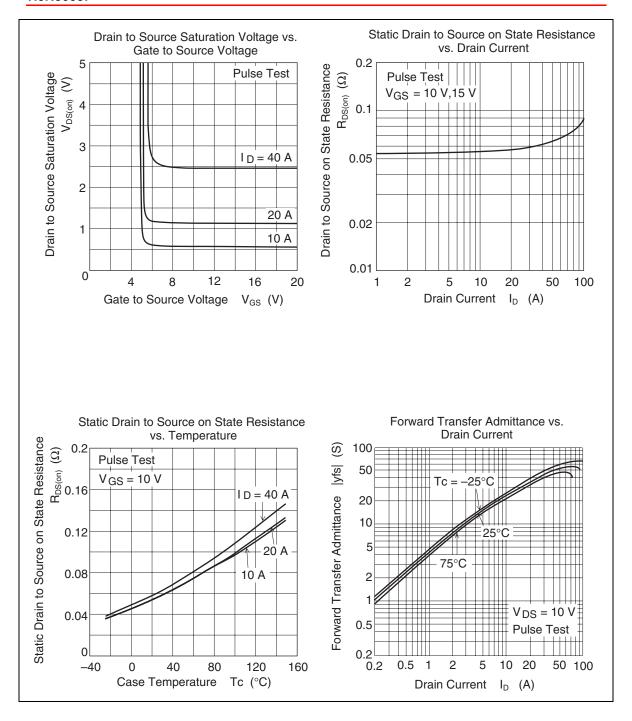
 $(Ta = 25^{\circ}C)$

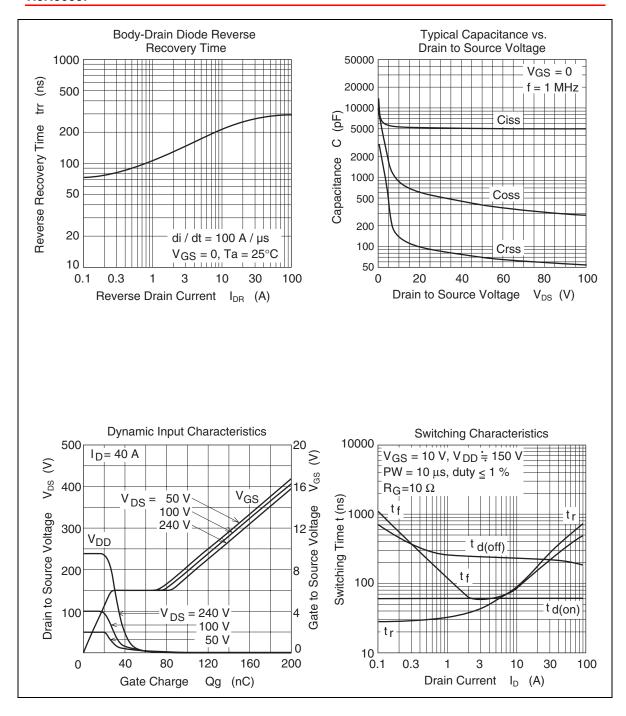
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	300	_	_	V	$I_D = 10 \text{mA}, V_{GS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 300V, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 30V, V_{DS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	3.0	_	4.0	V	$V_{DS} = 10V$, $I_D = 1mA$
Forward transfer admittance	y _{fs}	20	35	_	S	$I_D = 20A, V_{DS} = 10V^{Note4}$
Static drain to source on state resistance	R _{DS(on)}	_	0.058	0. 069	Ω	$I_D = 20A, V_{GS} = 10V^{Note4}$
Input capacitance	Ciss	_	5150	_	pF	V _{DS} = 25V
Output capacitance	Coss	_	560	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	90	_	pF	f = 1MHz
Turn-on delay time	td(on)	_	60	_	ns	I _D = 20A
Rise time	tr	_	185	_	ns	$R_L = 7.5\Omega$
Turn-off delay time	td(off)	_	220	_	ns	$V_{GS} = 10V$
Fall time	tf	_	150	_	ns	Rg=10 Ω
Total gate charge	Qg	_	130	_	nC	V _{DD} = 240V
Gate to source charge	Qgs	_	25	_	nC	$V_{GS} = 10V$
Gate to drain charge	Qgd	_	60	_	nC	$I_{D} = 40A$
Body-drain diode forward voltage	V_{DF}	_	1.0	1.5	V	I _F = 40A, V _{GS} = 0
Body-drain diode reverse recovery time	trr	_	280	_	ns	$I_F = 40A, V_{GS} = 0$ diF/dt=100A/ μ s
Body-drain diode reverse recovery charge	Qrr	_	2.5	_	μС	_

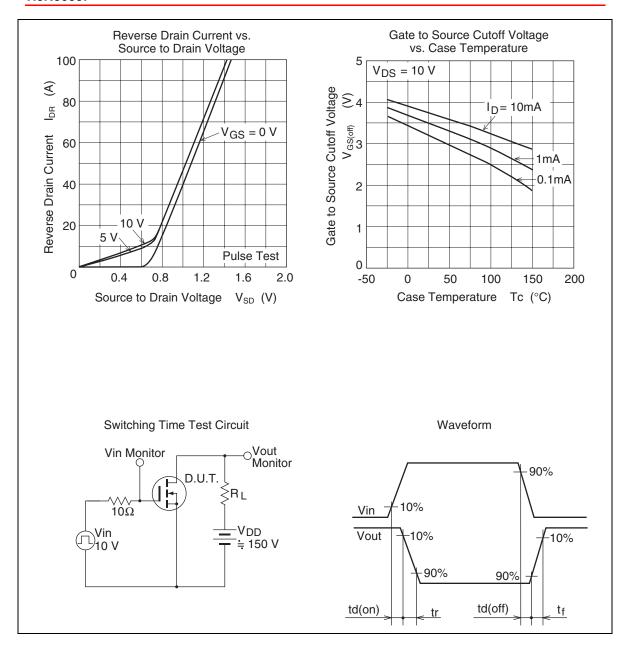
Notes: 4. Pulse test

Main Characteristics

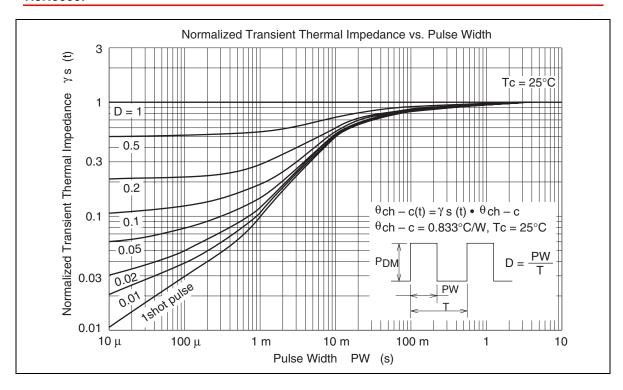




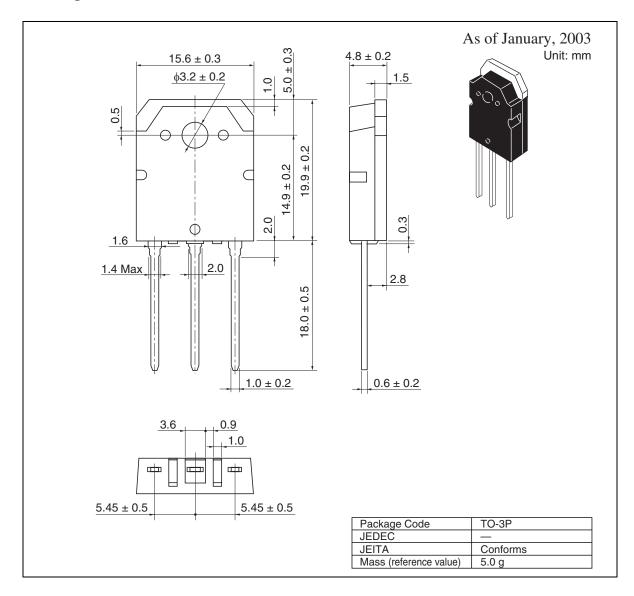




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Package Dimensions



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